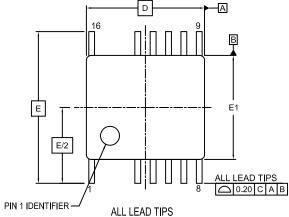




TSSOP16 MINUS PINS 2,3,14 & 15

CASE 948BW ISSUE O

DATE 18 AUG 2017

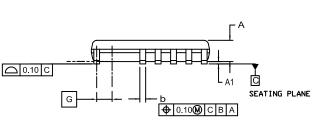


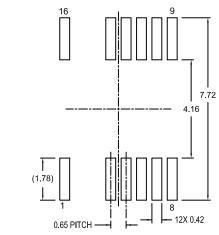
NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
- 4. MAXIMUM MOLD PROTRUSION 0.10 PER SIDE.
- 5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION.
 ALLOWABLE DAMBAR PROTRUSION SHALL NOT BE IN 0.13 TOTAL
 IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

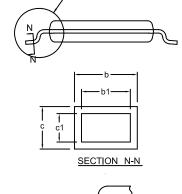
	MILLIMETERS		
DIM	MIN.	MAX.	
Α	-	1.20	
A1	0.05	0.15	
b	0.19	0.30	
b1	0.19	0.25	
С	0.09	0.20	
c1	0.09	0.16	
D	4.90	5.10	
E	6.40 BSC		
E1	4.30	4.50	
G	0.65 BSC		
L	0.50	0.75	
М	0°	8°	

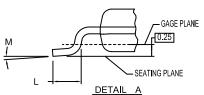
SEE DETAIL A





RECOMMENDED MOUNTING FOOTPRINT





GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

A = Assembly Location L = Wafer Lot

Y = Year W = Work Week

(Note: Microdot may be in either location)

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.

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